

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	HYUNCHUL SIM	12/05/2017
RECEIVING PARTY DATA		
Name:	HYUNDAI MOTOR COMPANY	
Street Address:	12, HEOLLEUNG-RO, SEOCHO-GU	
City:	SEOUL	
State/Country:	KOREA, REPUBLIC OF	
Postal Code:	06797	
Name:	KIA MOTORS CORPORATION	
Street Address:	12, HEOLLEUNG-RO, SEOCHO-GU	
City:	SEOUL	
State/Country:	KOREA, REPUBLIC OF	
Postal Code:	06797	
PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	15834678	
CORRESPONDENCE DATA		
Fax Number:	(202)756-8067	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
Phone:	202-756-8000	
Email:	ipdocketmwe@mwe.com, wdcipptsclerks@mwe.com, aziegler@mwe.com	
Correspondent Name:	MCDERMOTT WILL & EMERY LLP	
Address Line 1:	THE MCDERMOTT BUILDING	
Address Line 2:	500 NORTH CAPITOL STREET, N.W.	
Address Line 4:	WASHINGTON, D.C. 20001	
ATTORNEY DOCKET NUMBER:	086121-0553	
NAME OF SUBMITTER:	HOSANG LEE	
SIGNATURE:	/HOSANG LEE/	
DATE SIGNED:	12/07/2017	

Total Attachments: 3

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I believe I am the original or an original joint inventor of a claimed invention in the application for which a patent is sought on the invention entitled:

which application is:

- The above-identified application was made or authorized to be made by me.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I hereby assign to

having an address at 12, Heolleung-ro, Seocho-gu, Seoul, Republic of Korea

having an address at 12, Heolleung-ro, Seocho-gu, Seoul, Republic of Korea

I hereby confirm any prior assignment to Assignee, and to the extent that I have not already done so, agree to assign, and hereby do, sell, assign and transfer unto Assignee and its successors in interest, the full and exclusive right, title and interest in the United States of America and throughout the world, including the right to claim priority under the laws of the United States, the Paris Convention, and any foreign countries, to the inventions as described in the aforesaid application, to the aforesaid application itself, and all divisions, continuations, continuations-in-part, or other applications claiming priority directly or indirectly from the aforesaid application, and any United States or foreign Letters Patent, utility model, or other similar rights which may be granted thereon, including reissues, reexaminations and extensions thereof, and all copyright rights throughout the world in the aforesaid application and the subject matter disclosed therein, these rights, title and interest to be held and enjoyed by Assignee to the full end of the term for which the Letters Patent, utility model, or other similar rights, are granted and any extensions thereof as fully and entirely as the same would have been held by the undersigned had this assignment and sale not been made, and the right to sue for, and recover for past infringements of, or liabilities for, any of the rights relating to any of the applications, patents, utility models, or other similar rights, resulting therefrom, and the copyright rights;

I hereby covenant that no assignment, sale, license, agreement or encumbrance has been or will be entered into which would conflict with this Assignment.

Legal name of first inventor	
HyonChul SIM	
First inventor's signature	Date
	Dec 5 2019